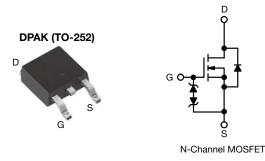
**Vishay Siliconix** 



# **E Series Power MOSFET**



PRODUCT SUMMARY				
V <sub>DS</sub> (V) at T <sub>J</sub> max.	850			
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.826		
Q <sub>g</sub> max. (nC)	22.5			
Q <sub>gs</sub> (nC)	4			
Q <sub>gd</sub> (nC)	7			
Configuration	Single			

### **FEATURES**

- Low figure-of-merit (FOM) Ron x Qa
- Low effective capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q<sub>q</sub>)
- Avalanche energy rated (UIS)
- Integrated Zener diode ESD protection
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

#### **APPLICATIONS**

- · Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Renewable energy

ORDERING INFORMATION		
Package	DPAK (TO-252)	
Lead (Pb)-free and halogen-free	SiHD6N80AE-GE3	
	SiHD6N80AET4-GE3	

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_C = 25 \text{ °C}$ , unless otherwise noted)					
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V <sub>DS</sub>	800	v
Gate-source voltage			V <sub>GS</sub>	± 30	v
Continuous drain current (T <sub>J</sub> = 150 °C)	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 25 °C T <sub>C</sub> = 100 °C		5	
	V <sub>GS</sub> at 10 V	$T_{\rm C} = 100 \ ^{\circ}{\rm C}$	١D	3.2	A
Pulsed drain current <sup>a</sup>		I <sub>DM</sub>	10		
Linear derating factor				0.5	W/°C
Single pulse avalanche energy <sup>b</sup>			E <sub>AS</sub>	20.3	mJ
Maximum power dissipation		PD	62.5	W	
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Drain-source voltage slope		T <sub>J</sub> = 125 °C 100			
Reverse diode dv/dt <sup>d</sup>		dv/dt	0.4	V/ns	
Soldering recommendations (peak temperature)	с	For 10 s		260	°C

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b.  $V_{DD}$  = 140 V, starting T<sub>J</sub> = 25 °C, L = 28.2 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 1.2 A

c. 1.6 mm from case

d.  $I_{SD} \leq I_D$ , di/dt = 100 A/µs, starting T<sub>J</sub> = 25 °C

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THERMAL RESISTANCE RATINGS								
PARAMETER	SYMBOL	TYP.		MAX.			UNIT	
Maximum junction-to-ambient	R <sub>thJA</sub>	- 62			80 AM			
Maximum junction-to-case (drain)	R <sub>thJC</sub>	- 2			°C/W			
<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 $^{\circ}$ C, u	unless otherwi	se noted)						
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT
Static								
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 2	250 µA	800	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_J$	Referenc	e to 25 °C,	I <sub>D</sub> = 1 mA	-	0.8	-	V/°C
Gate-source threshold voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	· V <sub>GS</sub> , I <sub>D</sub> = 2	250 µA	2	-	4	V
		N N	$V_{GS} = \pm 20 \text{ V}$		-	-	± 10	
Gate-source leakage	I <sub>GSS</sub>	N N	V <sub>GS</sub> = ± 30	V	-	-	± 50	μA
Zaro gata voltago drain ourrent		V <sub>DS</sub> =	800 V, V <sub>G</sub>	<sub>S</sub> = 0 V	-	-	1	
Zero gate voltage drain current	IDSS	V <sub>DS</sub> = 640 V	, V <sub>GS</sub> = 0 V	∕, T <sub>J</sub> = 125 °C	-	-	10	μA
Drain-source on-state resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 V$		<sub>D</sub> = 2 A	-	0.826	0.950	Ω
Forward transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub>	= 30 V, I <sub>D</sub>	= 3 A	-	1.9	-	S
Dynamic							•	•
Input capacitance	C <sub>iss</sub>		V <sub>GS</sub> = 0 V		-	422	-	
Output capacitance	C <sub>oss</sub>	· ·	$V_{\text{GS}} = 100 \text{ V},$ f = 1  MHz		-	24	-	
Reverse transfer capacitance	C <sub>rss</sub>				-	4	-	
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>	$V_{DS}$ = 0 V to 480 V, $V_{GS}$ = 0 V		-	17	-	pF	
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>			-	92	-		
Total gate charge	Qg				-	15	22.5	
Gate-source charge	Q <sub>gs</sub>	$V_{GS} = 10 V$	V <sub>GS</sub> = 10 V I <sub>D</sub> = 3 A, V <sub>DS</sub> = 640 V		-	4	-	nC
Gate-drain charge	Q <sub>gd</sub>				-	7	-	
Turn-on delay time	t <sub>d(on)</sub>				-	12	24	
Rise time	t <sub>r</sub>	V <sub>DD</sub> =	= 640 V, I <sub>D</sub>	= 3 A,	-	10	20	
Turn-off delay time	t <sub>d(off)</sub>	V <sub>GS</sub> =	$V_{GS}$ = 10 V, $R_g$ = 9.1 $\Omega$		-	16	32	ns
Fall time	t <sub>f</sub>	-			-	20	40	
Gate input resistance	R <sub>g</sub>	f = 1	MHz, oper	n drain	1	2	4	Ω
Drain-Source Body Diode Characteristi								
Continuous source-drain diode current	۱ <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	5		
Pulsed diode forward current	I <sub>SM</sub>			-	-	10	A	
Diode forward voltage	V <sub>SD</sub>	T,J = 25 °C	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 3 A, V <sub>GS</sub> = 0 V		-	-	1.2	V
Reverse recovery time	t <sub>rr</sub>				-	285	570	ns
Reverse recovery charge	Q <sub>rr</sub>	$T_J = 25 \text{ °C}, I_F = I_S = 3 \text{ A},$ di/dt = 100 A/µs, V <sub>R</sub> = 25 V		-	1.7	3.4	μC	
Reverse recovery current	I <sub>RRM</sub>			-	9.9	-	A	

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 V to 480 V  $V_{DSS}$ 

b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 V to 480 V  $V_{DSS}$ 



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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

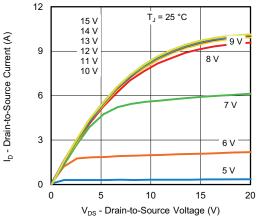


Fig. 1 - Typical Output Characteristics

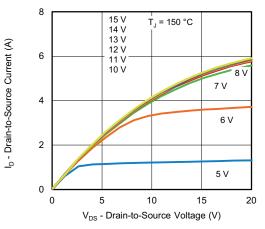


Fig. 2 - Typical Output Characteristics

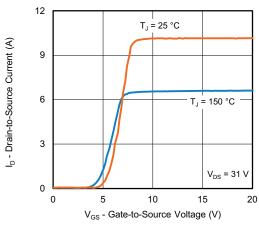


Fig. 3 - Typical Transfer Characteristics

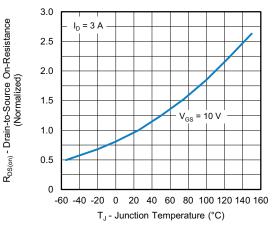


Fig. 4 - Normalized On-Resistance vs. Temperature

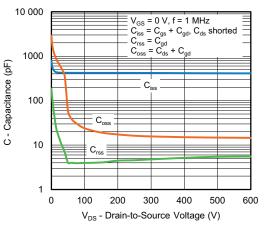
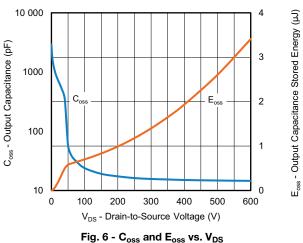


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage



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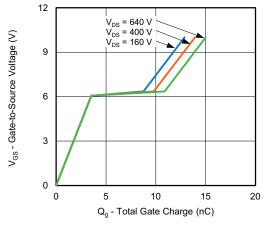


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

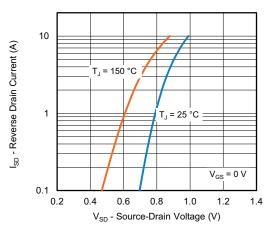


Fig. 8 - Typical Source-Drain Diode Forward Voltage

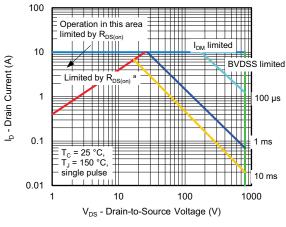


Fig. 9 - Maximum Safe Operating Area

Note

a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

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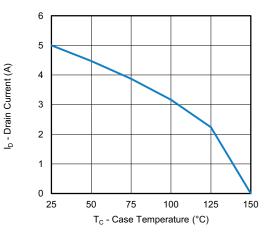


Fig. 10 - Maximum Drain Current vs. Case Temperature

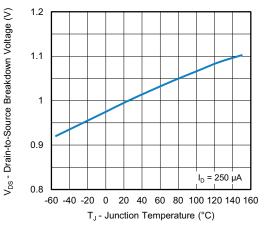


Fig. 11 - Temperature vs. Drain-to-Source Voltage



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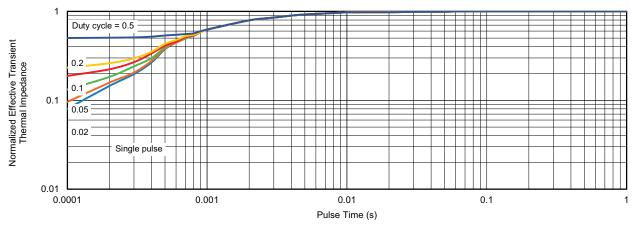


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

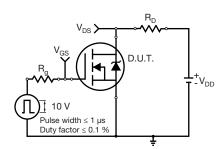


Fig. 13 - Switching Time Test Circuit

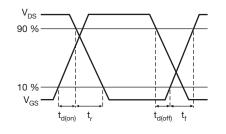


Fig. 14 - Switching Time Waveforms

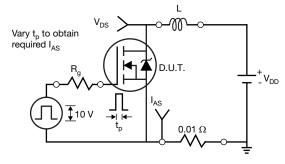


Fig. 15 - Unclamped Inductive Test Circuit

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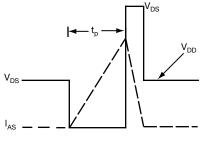


Fig. 16 - Unclamped Inductive Waveforms

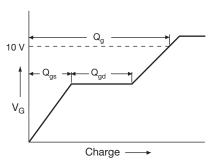
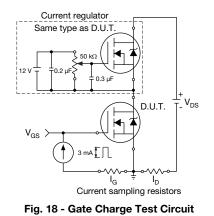


Fig. 17 - Basic Gate Charge Waveform





#### Peak Diode Recovery dv/dt Test Circuit

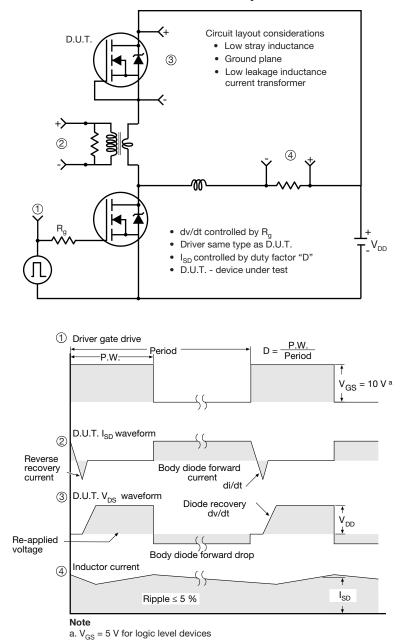


Fig. 19 - For N-Channel

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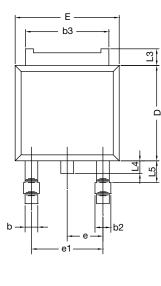
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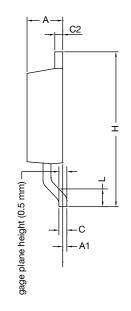


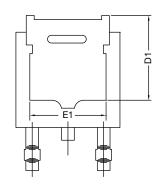


**TO-252AA Case Outline** 

### VERSION 1: FACILITY CODE = Y







	MILLIMETERS			
DIM.	MIN.	MAX.		
A	2.18	2.38		
A1	-	0.127		
b	0.64	0.88		
b2	0.76	1.14		
b3	4.95	5.46		
С	0.46	0.61		
C2	0.46	0.89		
D	5.97	6.22		
D1	4.10	-		
E	6.35	6.73		
E1	4.32	-		
Н	9.40	10.41		
е	2.28	2.28 BSC		
e1	4.56	4.56 BSC		
L	1.40	1.78		
L3	0.89	1.27		
L4	-	1.02		
L5	1.01	1.52		

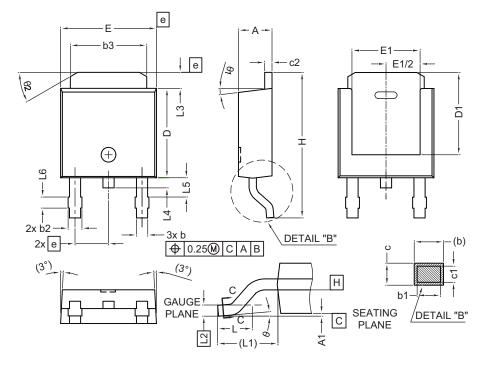
Note

• Dimension L3 is for reference only



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## VERSION 2: FACILITY CODE = N



	MILLIMETERS		
DIM.	MIN.	MAX.	
A	2.18	2.39	
A1	-	0.13	
b	0.65	0.89	
b1	0.64	0.79	
b2	0.76	1.13	
b3	4.95	5.46	
С	0.46	0.61	
c1	0.41	0.56	
c2	0.46	0.60	
D	5.97	6.22	
D1	5.21	-	
E	6.35	6.73	
E1	4.32 -		
e	2.29 BSC		
Н	9.94 10.34		

	MILLIMETERS		
DIM.	MIN.	MAX.	
L	1.50	1.78	
L1	2.74 ref.		
L2	0.51 BSC		
L3	0.89	1.27	
L4	-	1.02	
L5	1.14	1.49	
L6	0.65	0.85	
θ	0°	10°	
θ1	0°	15°	
θ2	25° 35°		

#### Notes

• Dimensioning and tolerance confirm to ASME Y14.5M-1994

• All dimensions are in millimeters. Angles are in degrees

• Heat sink side flash is max. 0.8 mm

Radius on terminal is optional

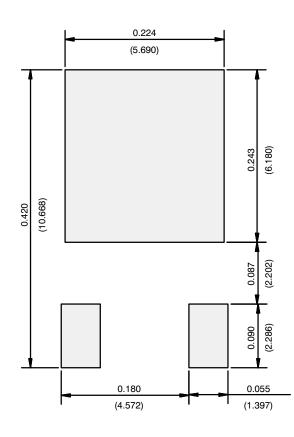
ECN: E22-0399-Rev. R, 03-Oct-2022 DWG: 5347

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## **RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)**



Recommended Minimum Pads Dimensions in Inches/(mm)

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